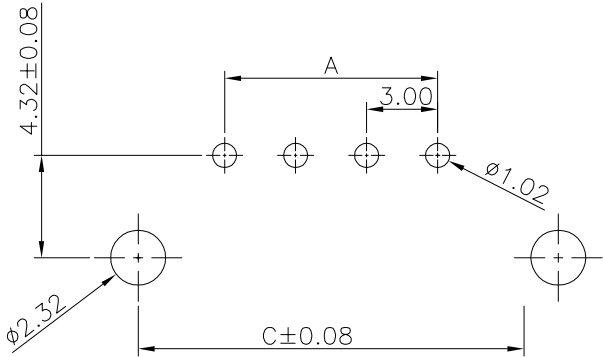
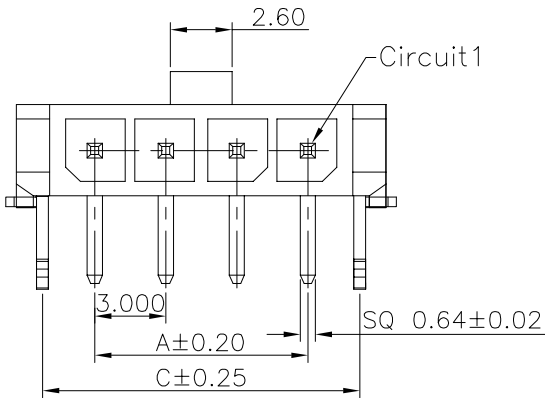
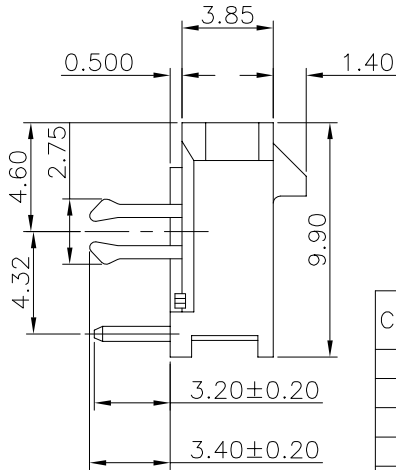
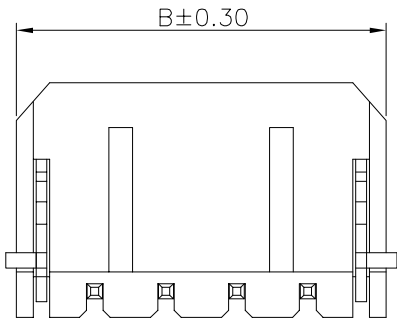


The product using material and processing must conform to the "WL-PZ-001"HSF technical standard control requirements

RoHS



Recommended P.C.B Layout
General Tolerance±0.05



- NOTE:
- 1.MATERIAL SPECIFICATION:
 - 1-1.HOUSING: LCP,UL94V-0
 - 1-2.CONTACTS: BRASS
 - 1-3.Board lock: BRASS
 - 2.PLATING SPECIFICATION:
 - 2-1.CONTACTS:
 - TIN/GOLD FLASH PLATED OVER ALL.
 - 2-2.SOLDER TABS:
 - TIN/GOLD FLASH PLATED OVER ALL.
 - 3.MECHANICAL PERFORMANCE:
 - 3-1.RETENTIVITY FORCE: 1.0KGF/pin min
 - 3-2.DURABILITY: 30 CYCLES.
 - 4.ELECTRICAL PERFORMANCE:
 - 4-1.CURRENT RATING: 5A AC/DC
 - RATED VOLTAGE : 250V AC/DC
 - 4-2.CONTACT RESISTANCE: 10 mΩ MAX
 - 4-3.INSULATION RESISTANCE: 1000MΩ Min
 - 4-4.DIELECTRIC WITHSTANDING : 1000V
 - 5.ENVIRONMENTAL PERFORMANCE:
 - 5-1.OPERATING TEMPERATURE: -25°C~+85°C.
 - 6.PACKAGE SPEC: PE BAG
 - 7.P/N:

C30301 F 9-1 XX 1 X X 0

SERIES NO: _____

MALE FEMALE: _____

F-FEMALE _____

ANGLE: _____

9-90° _____

0-180° _____

ROW NO: _____

1-SINGLE ROW _____

PIN Q'PY: _____

02~12 _____

COLOR: _____

A-BLACK _____

K-WHITE _____

S-NATURE _____

PLATING: _____

A-ALL AU G/F _____

C-BRIGHE TIN _____

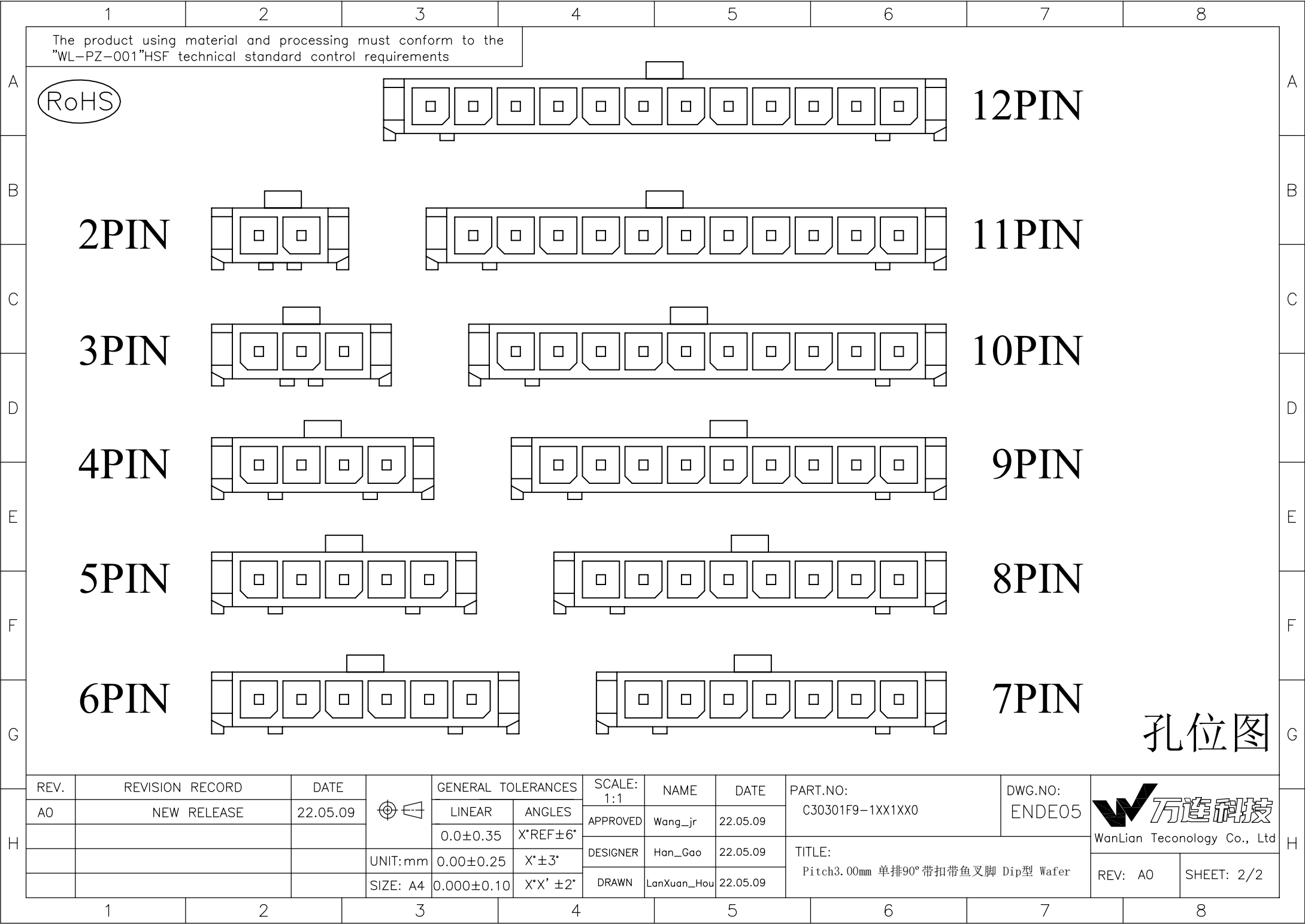
D-MATTE Tin _____

TERMIPOINT: _____

1-DIP _____

Circuit	Dimensions(mm)			Circuit	Dimensions(mm)		
	A	B	C		A	B	C
01	---	6.65	4.30	07	18.00	24.65	21.30
02	3.00	9.65	7.30	08	21.00	27.65	24.30
03	6.00	12.65	10.30	09	24.00	30.65	27.30
04	9.00	15.65	13.30	10	27.00	33.65	30.30
05	12.00	18.65	16.30	11	30.00	36.65	33.30
06	15.00	21.65	19.30	12	33.00	39.65	36.30

REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE: 1:1	NAME	DATE	PART.NO: C30301F9-1XX1XX0	DWG.NO: ENDE05		
A0	NEW RELEASE	22.05.09		LINEAR	ANGLES	APPROVED	Wang_jr	22.05.09				
				0.0±0.35	X°REF±6°							
				UNIT:mm	0.00±0.25	X°±3°	DESIGNER	Han_Gao	22.05.09	TITLE: Pitch3.00mm 单排90°带扣带鱼叉脚 Dip型 Wafer		
				SIZE: A4	0.000±0.10	X°X' ±2°	DRAWN	LanXuan_Hou	22.05.09			
											WanLian Teconology Co., Ltd	
											REV: A0	SHEET: 1/2



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RoHS

12PIN

11PIN

10PIN

9PIN

8PIN

7PIN

孔位图

REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE: 1:1	NAME	DATE	PART.NO: C30301F9-1XX1XX0	DWG.NO: ENDE05		
A0	NEW RELEASE	22.05.09		LINEAR	ANGLES	APPROVED	Wang_jr	22.05.09				
				0.0±0.35	X°REF±6°	DESIGNER	Han_Gao	22.05.09	TITLE: Pitch3.00mm 单排90°带扣带鱼叉脚 Dip型 Wafer		REV: A0	SHEET: 2/2
				UNIT:mm	0.00±0.25	X°±3°	DRAWN	LanXuan_Hou				
			SIZE: A4	0.000±0.10	X°X' ±2°							